

# 2SB1691

# Silicon PNP Epitaxial Planer Low Frequency Power Amplifier

REJ03G0482-0200 (Previous ADE-208-1387A (Z)) Rev.2.00 Dec.09.2004

### **Features**

• Small size package: MPAK (SC–59A)

• Large Maximum current:  $I_C = -1$  A

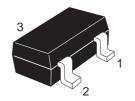
• Low collector to emitter saturation voltage:  $V_{CE(sat)} = -0.3 \text{ V max.} (\text{at } I_C/I_B = -0.5 \text{ A}/-0.05 \text{ A})$ 

• High power dissipation:  $P_C = 800 \text{ mW}$  (when using alumina ceramic board (25 x 60 x 0.7 mm))

• Complementary pair with 2SD2655

### **Outline**

**MPAK** 



- 1. Emitter
- 2. Base
- 3. Collector

Note: Marking is "WL-".

## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

| Item                         | Symbol         | Ratings     | Unit |
|------------------------------|----------------|-------------|------|
| Collector to base Voltage    | $V_{CBO}$      | -60         | V    |
| Collector to emitter voltage | $V_{\sf CEO}$  | -50         | V    |
| Emitter to base voltage      | $V_{EBO}$      | -6          | V    |
| Collector current            | Ic             | -1          | A    |
| Collector peak current       | ic(peak)       | -2          | A    |
| Collector power dissipation  | P <sub>C</sub> | 800*        | mW   |
| Junction temperature         | Tj             | 150         | °C   |
| Storage temperature          | Tstg           | -55 to +150 | °C   |

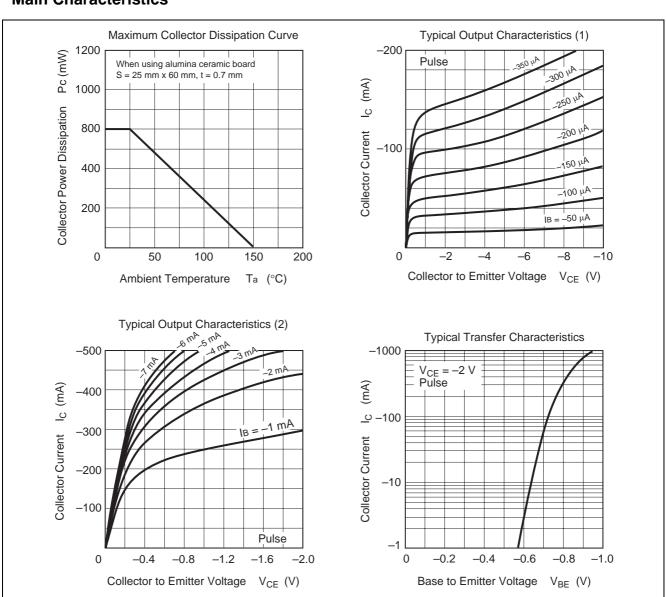
Note: \*When using alumina ceramic board (25 x 60 x 0.7 mm)

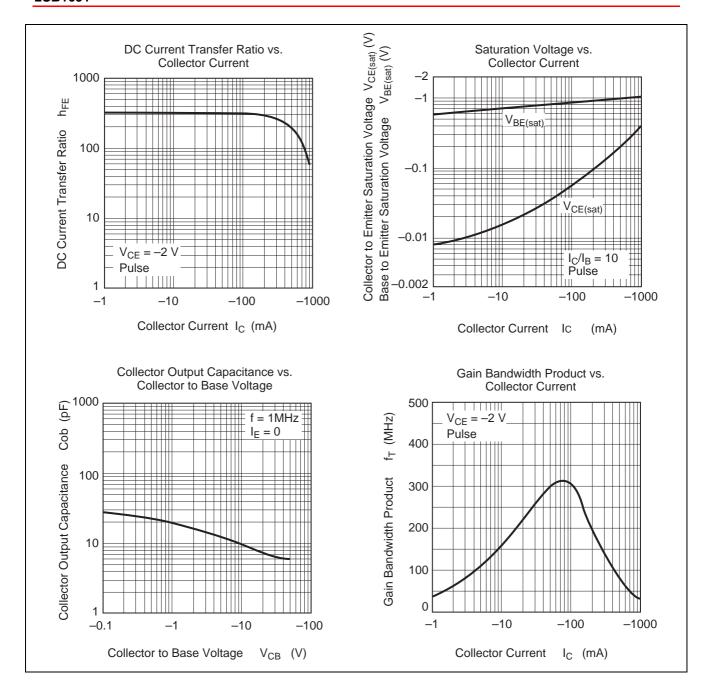
### **Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

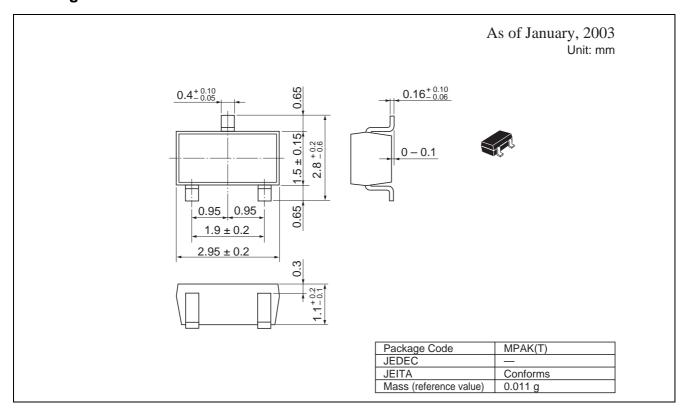
| Item                                    | Symbol               | Min | Тур   | Max  | Unit | Test Condition   |
|---|----------------------|-----|-------|------|------|--|
| Collector to base breakdown voltage     | $V_{(BR)CBO}$        | -60 | _     | _    | V    | $I_C = -10 \mu\text{A}, \ I_E = 0$                               |
| Collector to emitter breakdown voltage  | $V_{(BR)CEO}$        | -50 |       | _    | V    | $I_C = -1 \text{ mA}, R_{BE} = \infty$                           |
| Emitter to base breakdown voltage       | $V_{(BR)EBO}$        | -6  |       | _    | V    | $I_E = -10 \mu\text{A}, \ I_C = 0$                               |
| Collector cutoff current                | I <sub>CBO</sub>     |     | _     | -100 | nA   | $V_{CB} = -50 \text{ V}, I_{E} = 0$                              |
| Emitter cutoff current                  | I <sub>EBO</sub>     |     | _     | -100 | nA   | $V_{EB} = -5 \text{ V}, I_{C} = 0$                               |
| DC current transfer ratio               | h <sub>FE</sub>      | 200 | _     | 500  |      | $V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$                  |
| Collector to emitter saturation voltage | V <sub>CE(sat)</sub> | _   | -0.2  | -0.3 | V    | $I_C = -0.5 \text{ A}, I_B = -0.05 \text{ A},$<br>Pulse test     |
| Base to emitter saturation voltage      | V <sub>BE(sat)</sub> | _   | -0.95 | -1.2 | V    | $I_{C} = -0.5 \text{ A}, I_{B} = -0.05 \text{ A},$<br>Pulse test |
| Gain bandwidth product                  | f⊤                   |     | 310   | _    | MHz  | $V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$                  |
| Collector output capacitance            | Cob                  |     | 9.8   | _    | pF   | $V_{CB} = -10 \text{ V}, I_E = 0,$<br>f = 1 MHz                  |

### **Main Characteristics**





# **Package Dimensions**



# **Ordering Information**

| Part Name           | Quantity | Shipping Container  |
|---------------------|----------|---------------------|
| 2SB1691WL- 3000 pcs |          | φ178 mm Taping Reel |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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